


SMA6L Series



Agency Approvals

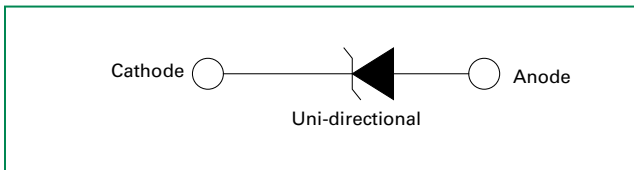
AGENCY	AGENCY FILE NUMBER
	E230531

Maximum Ratings and Thermal Characteristics (T_A = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at T _A = 25°C by 10/1000µs Waveform (Fig.2)(Note 1), (Note 2)	P _{PPM}	600	W
Power Dissipation on Infinite Heat Sink at T _L = 50°C	P _D	3	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I _{FSM}	60	A
Maximum Instantaneous Forward Voltage at 25A for Unidirectional Only	V _F	3.5	V
Operating Temperature Range	T _J	-65 to 150	°C
Storage Temperature Range	T _{STG}	-65 to 175	°C
Typical Thermal Resistance Junction to Lead	R _{θJL}	35	°C/W
Typical Thermal Resistance Junction to Ambient	R _{θJA}	200	°C/W

- Notes:**
1. Non-repetitive current pulse, per Fig.4 and derated above T_J (initial) = 25°C per Fig. 3.
 2. Mounted on 5.0x5.0mm copper pad to each terminal.
 3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only.

Functional Diagram



Description

The SMA6L series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

SMA low profile package has the same electrical performance as the SMB package but with lowest height profiles (1.1mm) in the industry.

Features

- Same power as standard SMB devices (600 W)
- SMA low profile package: less than 1.1 mm
- Footprint compatibility with standard SMA and SMB products (easy to layout)
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 30kV(Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2
- EFT protection of data lines in accordance with IEC 61000-4-4
- Low inductance, excellent clamping capability
- Fast response time: typically less than 1.0ns from 0 Volts to V_{BR min}
- Built-in strain relief
- Glass passivated junction
- Typical I_R less than 1µA when V_{BR min} > 12V
- High temperature to reflow soldering guaranteed: 260°C/40sec
- V_{BR} @ T_J = V_{BR} @ 25°C x (1 + α T x (T_J - 25)) (α T: Temperature Coefficient, typical value is 0.1%)
- Plastic package is flammability rated V-0 per Underwriters Laboratories
- Meet MSL level1, per J-STD-020, LF maximum peak of 260°C
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

Applications

TVS devices are ideal for the protection of I/O Interfaces, V_{CC} bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

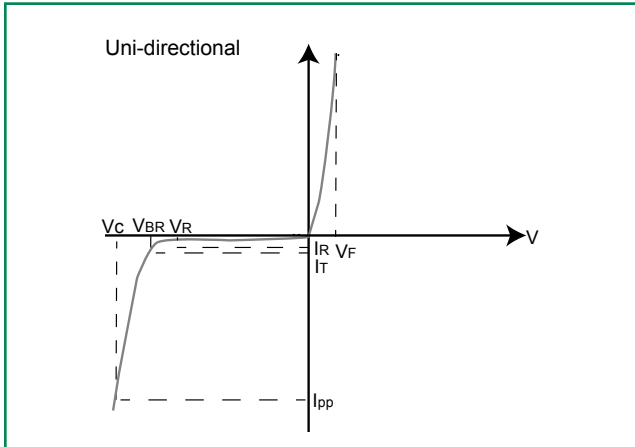
Additional Information



Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Part Number (Uni)	Marking Code	Reverse Stand off Voltage V_R (Volts)	Breakdown Voltage V_{BR} (Volts) @ I_T		Test Current I_T (mA)	Maximum Clamping Voltage V_C @ I_{PP} (V)	Maximum Peak Pulse Current I_{PP} (A)	Maximum Reverse Leakage I_R @ V_R (μA)	Agency Approval
			MIN	MAX					
SMA6L5.0A	AE	5.0	6.40	7.00	10	9.2	65.3	800	X
SMA6L6.0A	AG	6.0	6.67	7.37	10	10.3	58.3	800	X
SMA6L6.5A	AK	6.5	7.22	7.98	10	11.2	53.6	500	X
SMA6L7.0A	AM	7.0	7.78	8.60	10	12.0	50.0	200	X
SMA6L7.5A	AP	7.5	8.33	9.21	1	12.9	46.6	100	X
SMA6L8.0A	AR	8.0	8.89	9.83	1	13.6	44.2	50	X
SMA6L8.5A	AT	8.5	9.44	10.40	1	14.4	41.7	20	X
SMA6L9.0A	AV	9.0	10.00	11.10	1	15.4	39.0	10	X
SMA6L10A	AX	10.0	11.10	12.30	1	17.0	35.3	5	X
SMA6L11A	AZ	11.0	12.20	13.50	1	18.2	33.0	1	X
SMA6L12A	BE	12.0	13.30	14.70	1	19.9	30.2	1	X
SMA6L13A	BG	13.0	14.40	15.90	1	21.5	28.0	1	X
SMA6L14A	BK	14.0	15.60	17.20	1	23.2	25.9	1	X
SMA6L15A	BM	15.0	16.70	18.50	1	24.4	24.6	1	X
SMA6L16A	BP	16.0	17.80	19.70	1	26.0	23.1	1	X
SMA6L17A	BR	17.0	18.90	20.90	1	27.6	21.8	1	X
SMA6L18A	BT	18.0	20.00	22.10	1	29.2	20.6	1	X
SMA6L20A	BV	20.0	22.20	24.50	1	32.4	18.6	1	X
SMA6L22A	BX	22.0	24.40	26.90	1	35.5	16.9	1	X
SMA6L24A	BZ	24.0	26.70	29.50	1	38.9	15.5	1	X
SMA6L26A	CE	26.0	28.90	31.90	1	42.1	14.3	1	X
SMA6L28A	CG	28.0	31.10	34.40	1	45.4	13.3	1	X
SMA6L30A	CK	30.0	33.30	36.80	1	48.4	12.4	1	X
SMA6L33A	CM	33.0	36.70	40.60	1	53.3	11.3	1	X
SMA6L36A	CP	36.0	40.00	44.20	1	58.1	10.4	1	X
SMA6L40A	CR	40.0	44.40	49.10	1	64.5	9.3	1	X
SMA6L43A	CT	43.0	47.80	52.80	1	69.4	8.7	1	X
SMA6L45A	CV	45.0	50.00	55.30	1	72.7	8.3	1	X
SMA6L48A	CX	48.0	53.30	58.90	1	77.4	7.8	1	X
SMA6L51A	CZ	51.0	56.70	62.70	1	82.4	7.3	1	X
SMA6L54A	RE	54.0	60.00	66.30	1	87.1	6.9	1	X
SMA6L58A	RG	58.0	64.40	71.20	1	93.6	6.5	1	X
SMA6L60A	RK	60.0	66.70	73.70	1	96.8	6.2	1	X
SMA6L64A	RM	64.0	71.10	78.60	1	103.0	5.9	1	X
SMA6L70A	RP	70.0	77.80	86.00	1	113.0	5.3	1	X
SMA6L75A	RR	75.0	83.30	92.10	1	121.0	5.0	1	X
SMA6L78A	RT	78.0	86.70	95.80	1	126.0	4.8	1	X
SMA6L85A	RV	85.0	94.40	104.00	1	137.0	4.4	1	X

I-V Curve Characteristics



P_{PPM} Peak Pulse Power Dissipation – Max power dissipation

V_R Stand-off Voltage – Maximum voltage that can be applied to the TVS without operation

V_{BR} Breakdown Voltage – Maximum voltage that flows through the TVS at a specified test current (I_T)

V_C Clamping Voltage – Peak voltage measured across the TVS at a specified I_{ppm} (peak impulse current)

I_R Reverse Leakage Current – Current measured at V_R

V_F Forward Voltage Drop for Uni-directional

Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform

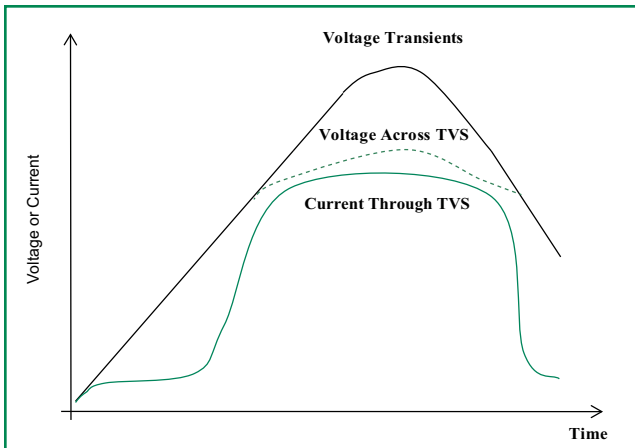
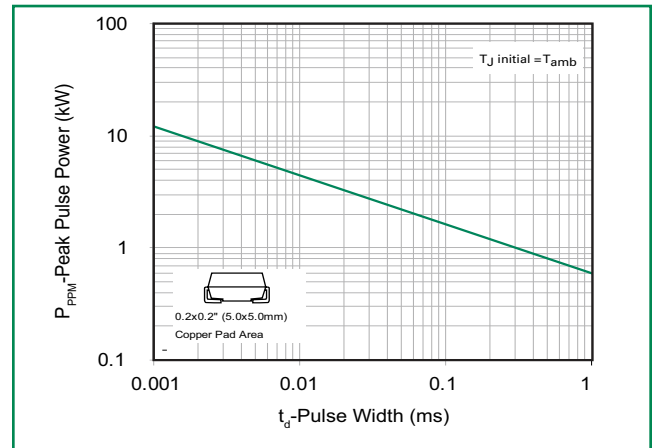


Figure 2 - Peak Pulse Power Rating Curve



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Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted) (Continued)

Figure 3 - Peak Pulse Power Derating Curve

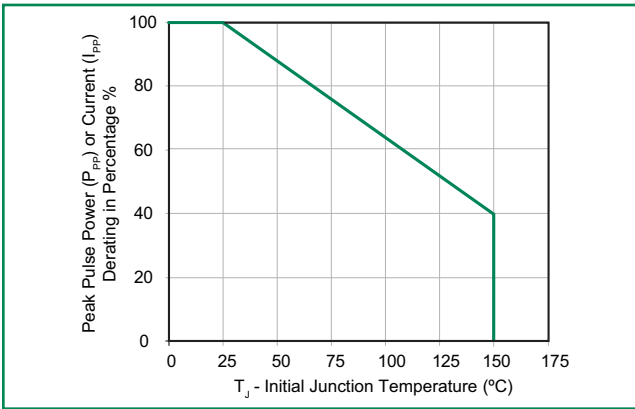


Figure 4 - Pulse Waveform

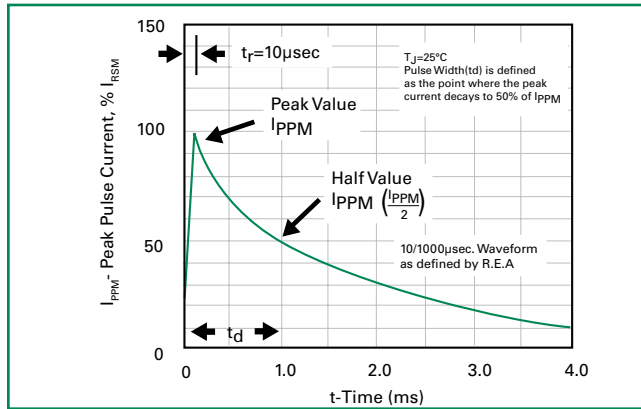


Figure 5 - Typical Junction Capacitance

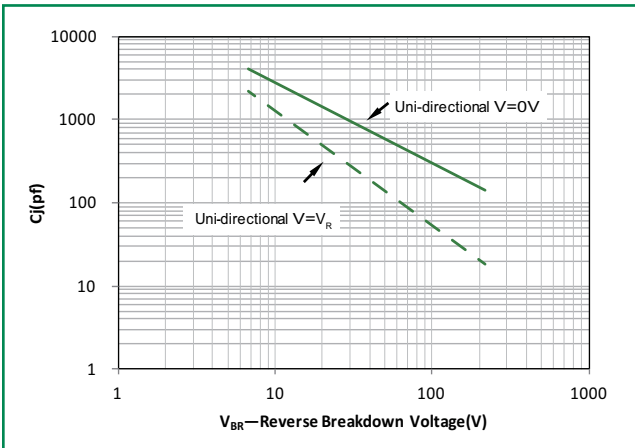


Figure 6 - Maximum Non-Repetitive Forward Surge Current Uni-Directional Only

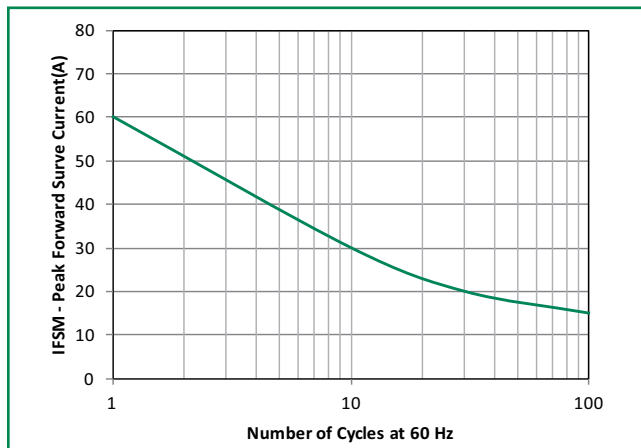
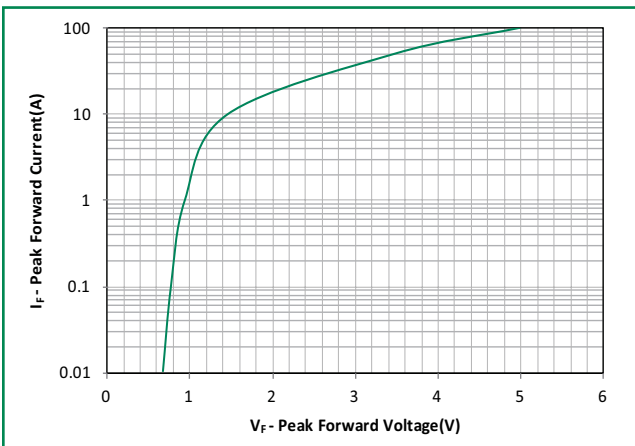
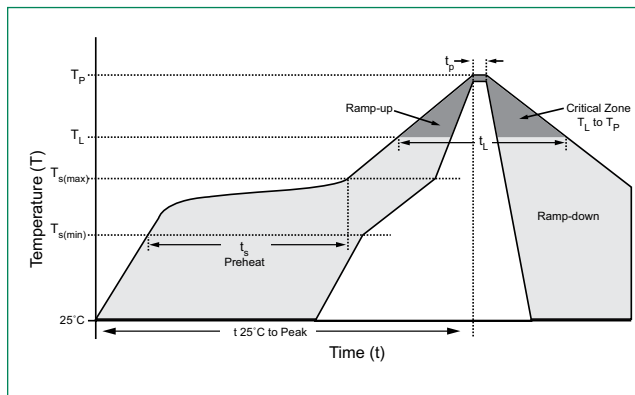


Figure 7 - Peak Forward Voltage Drop vs Peak Forward Current (typical values)



Soldering Parameters

Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_A) to peak)		3°C/second max
$T_{s(max)}$ to T_A - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_A) (Liquidus)	217°C
	- Time (min to max) (t_s)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		260°C



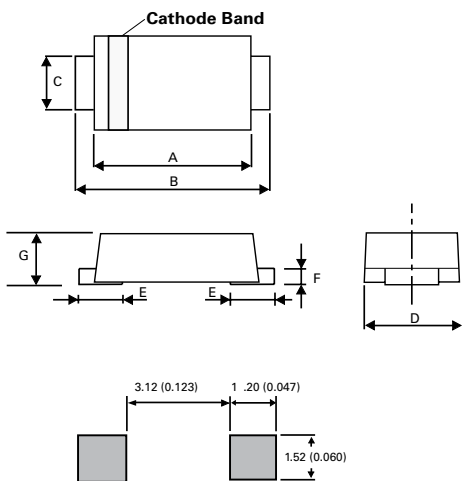
Physical Specifications

Weight	0.002 ounce, 0.032 gram
Case	JEDEC DO-221AC Molded Plastic over glass passivated junction
Polarity	Color band denotes cathode except Bipolar
Terminal	Matte Tin-plated leads, Solderable per JESD22-B102

Environmental Specifications

High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Temperature Cycling	JESD22-A104
MSL	JEDEC-J-STD-020, Level 1
H3TRB	JESD22-A101
RSH	JESD22-A111

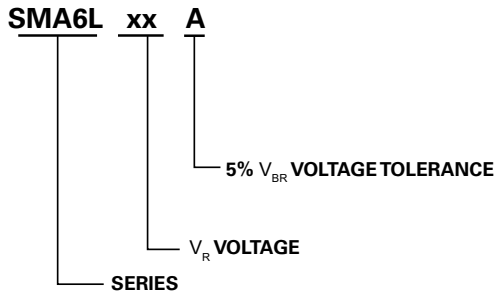
Dimensions



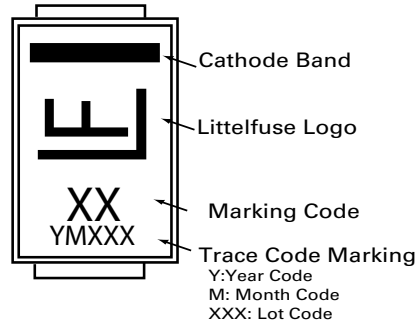
Mounting Pad Layout

Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.156	0.181	3.950	4.600
B	0.189	0.220	4.800	5.600
C	0.049	0.069	1.250	1.750
D	0.088	0.116	2.250	2.950
E	0.030	0.059	0.750	1.500
F	0.005	0.010	0.125	0.250
G	0.035	0.043	0.900	1.100

Part Numbering System



Part Marking System



Packaging

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMA6LxxA	DO-221AC	3000	Tape & Reel – 12mm/7" tape	EIA RS-481

Tape and Reel Specification

